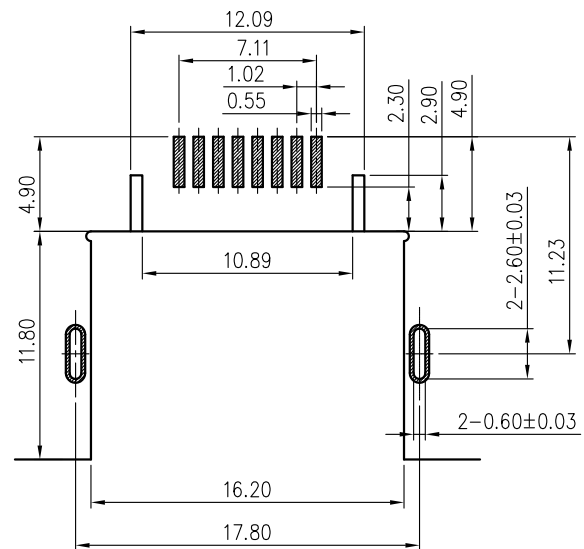
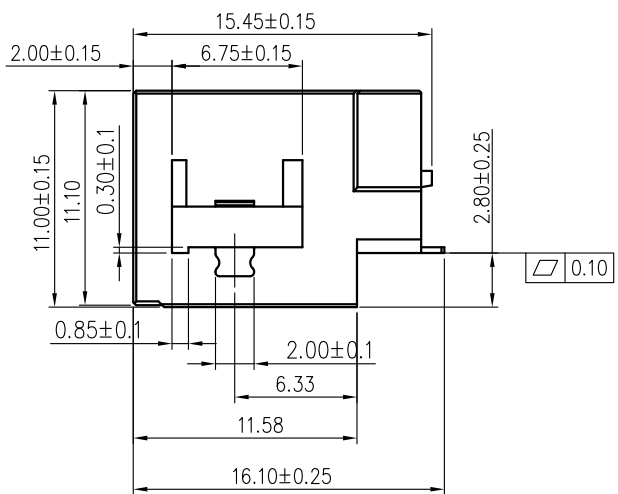
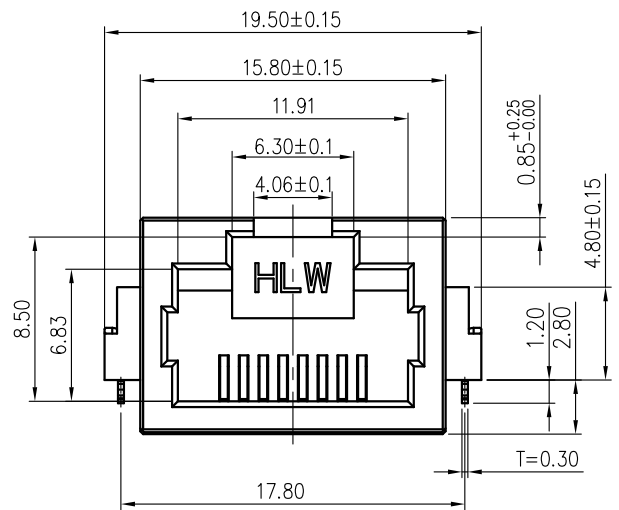
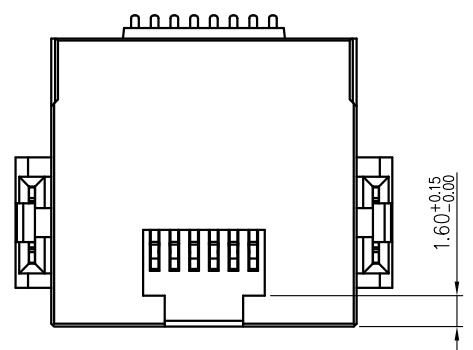


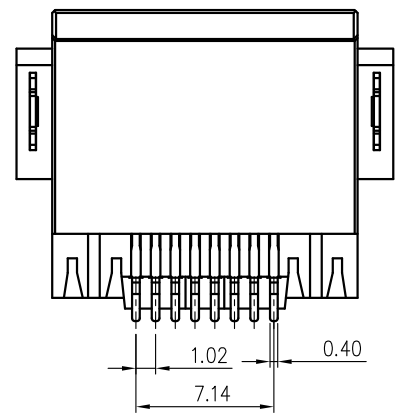
REV.	ECN.NO.	APPD.

- NOTES:
- MATERIAL:
 - Housing:thermoplastic plastics
 - terminals:Copper Alloy
Gold plated in contact area:
OR Gold Plated overall
 - Shell:Steel&Copper Alloy
Nickel/Tin Plated overall
 - ELECTRICAL CHARACTERISTICS:
 - Rating Current :1.5 Ampere
 - Rating Voltage :125 V Max
 - Contact Resistance:50 Milli ohms
 - Insulation Resistance:500 Mega ohms Min.
 - MECHANICAL CHARACTERISTICS:
 - Connector Mating force: 2.27kgf MAX
 - Durability:750Cycles.
 - ENVIRONMENT CHARACTERISTICS:
 - Operating temperature:-40℃ to +85℃
 - Storage temperature:-10℃ to +40℃



PCB LAYOUT(TOLERANCE±0.05)

R5G0-11200-G31081
 G:半金G/F
 3:PA9T
 1:RoHS UL94V-0
 8:载带
 0:冷封
 1:黑色



TOLERANCE UNLESS OTHERWISE SPECIFIED		HLW 深圳市华联威电子科技有限公司			
.XXX ±0.30	.XX ±0.20	.X ±0.10	HUA LIAN WEI TECHNOLOGY ELECTRONICS CO;LTD.		
.x' ±5°	.xx' ±2°	APPROVED			
PART NAME:		RJ45沉板SMT 带DIP脚 载带			
CHECKED		PART No:		R5G0-11200-G31081	
DRAWN		PROJECTION:		UNIT:	SCALE
DATE		2018.06.19		mm	1:1
		SHEET		REV.	
		10F1		C	